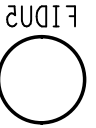
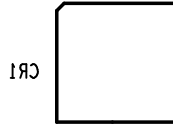
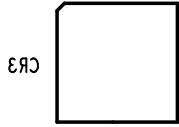


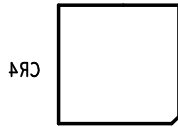
Σlights W



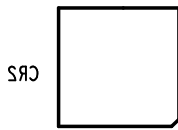
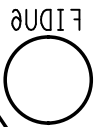
Model : Σlights



Rev. 1.0
Max 5.2V
Max 820mA



Hot Surface
Caution

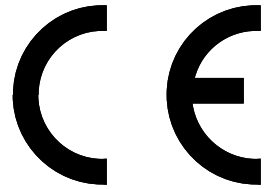


OSRAM

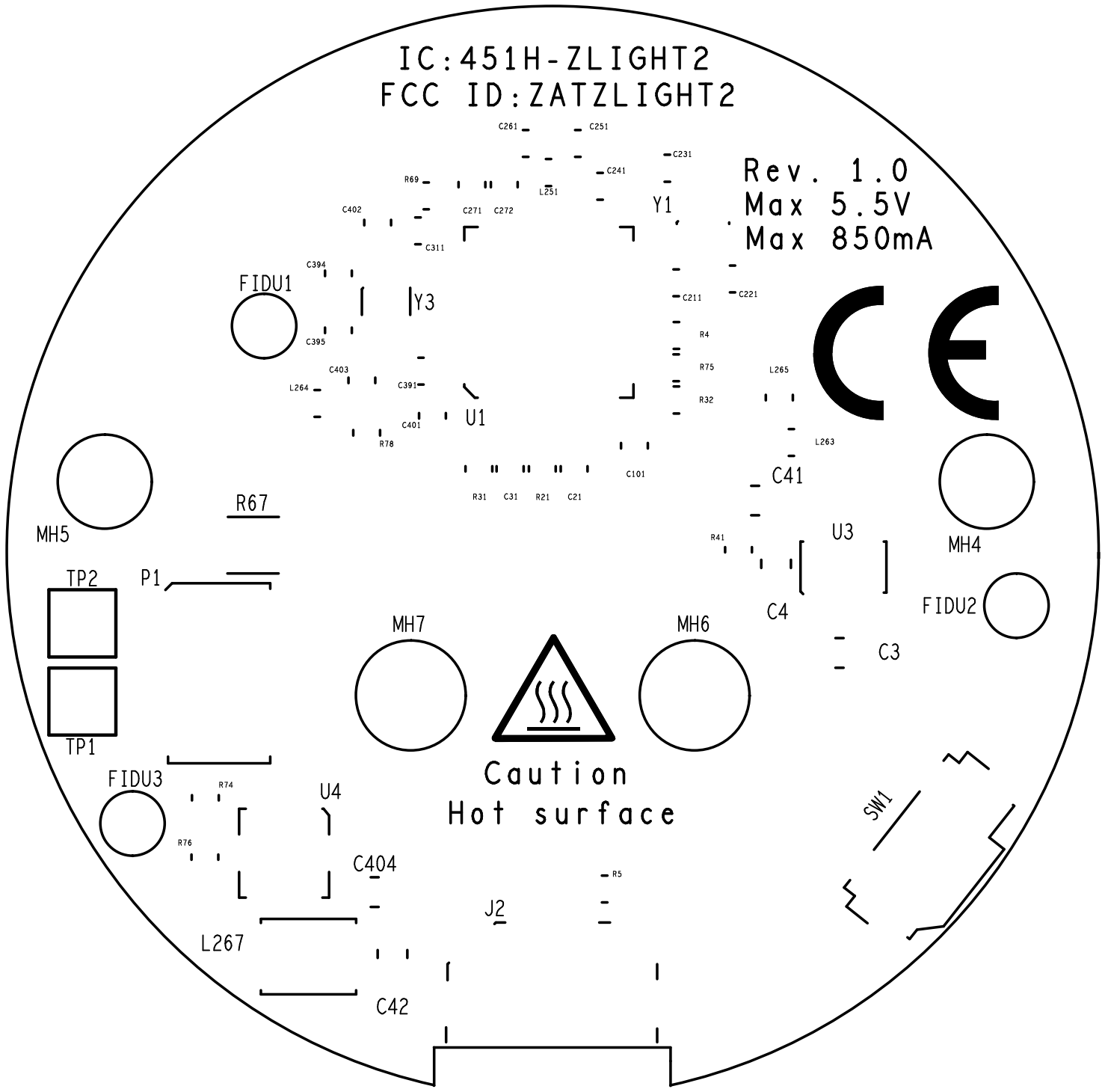
Opto Semiconductor

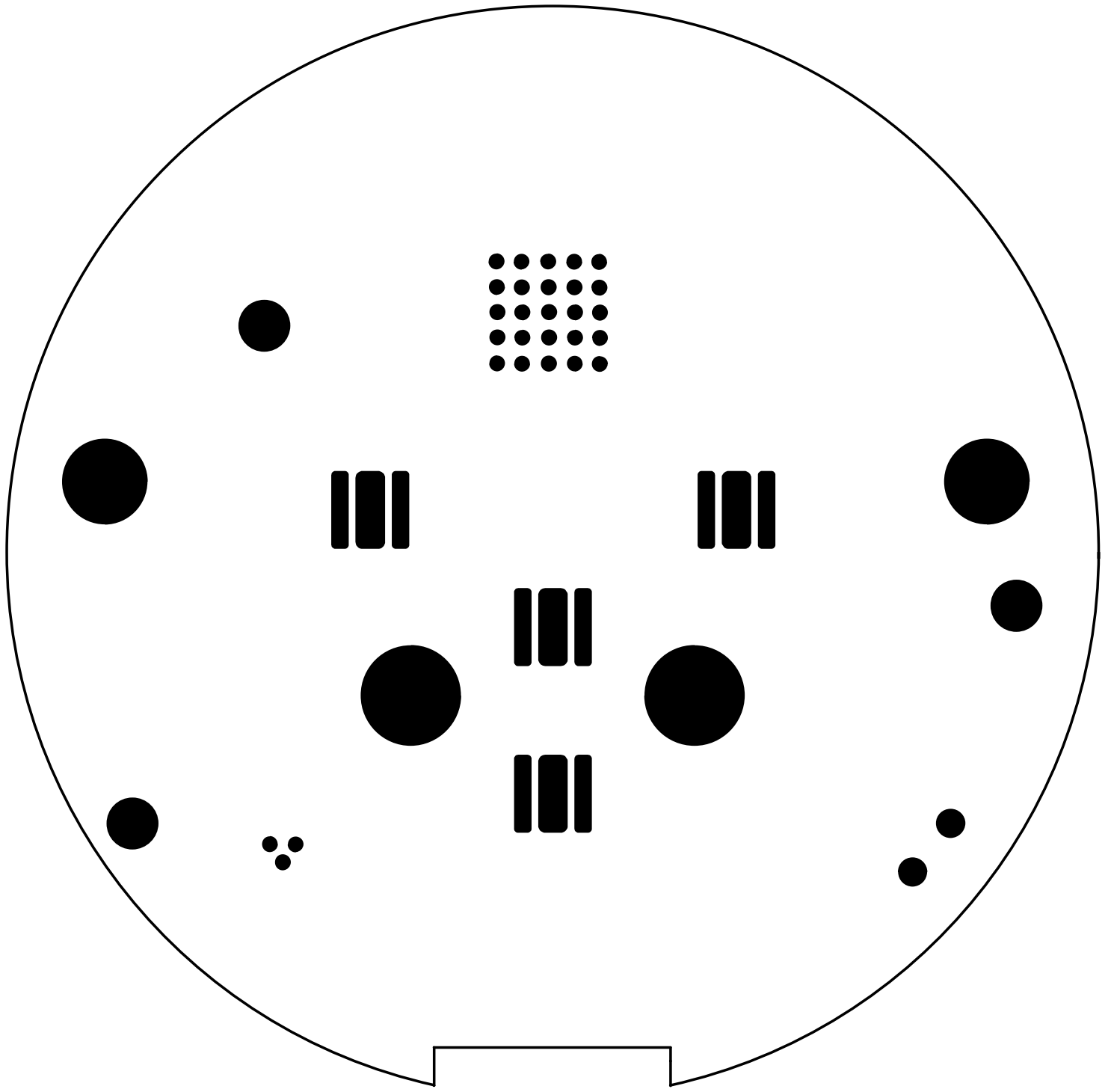
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FCC ID: ZATZLIGHT2

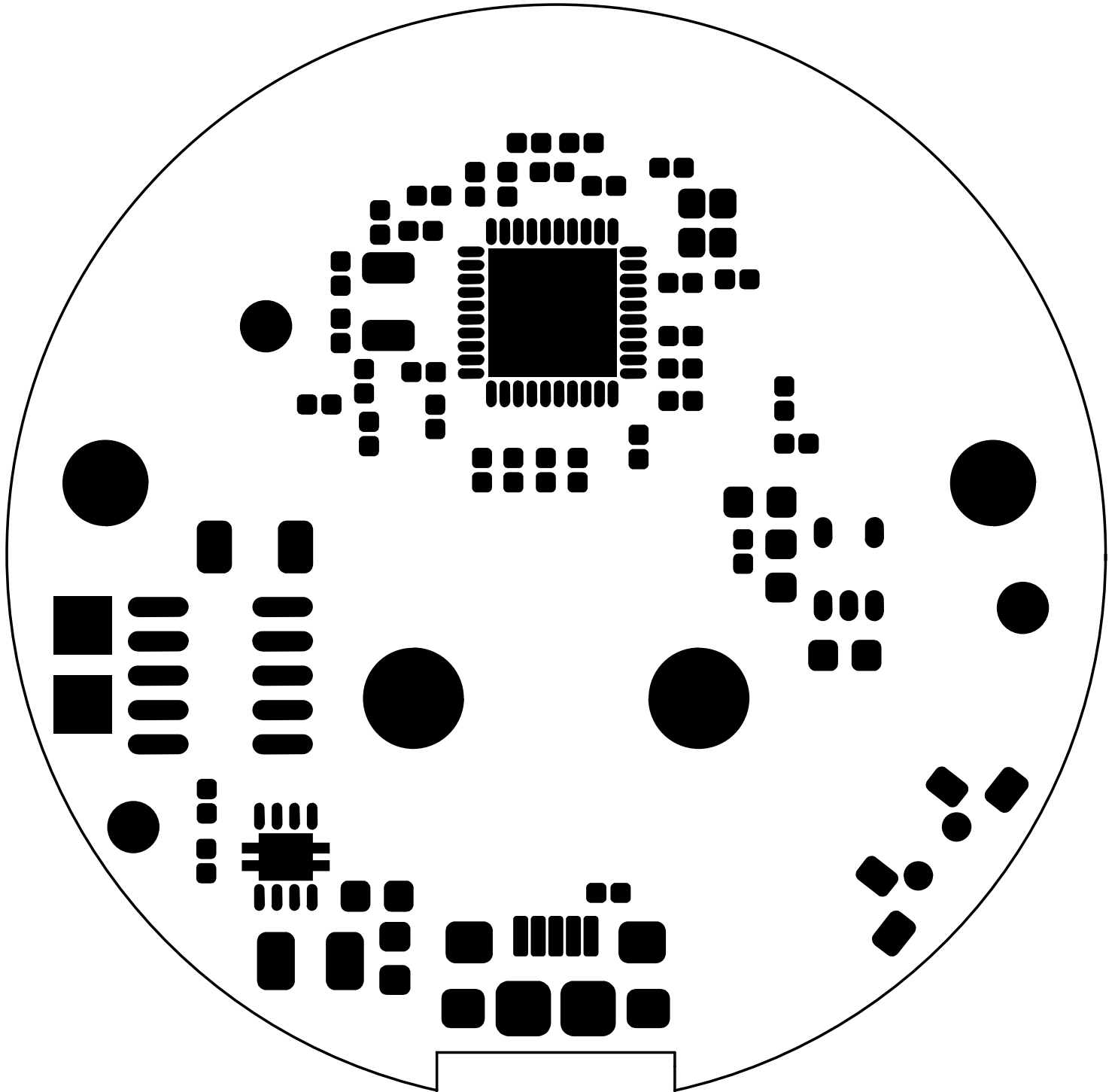
Rev. 1.0
Max 5.5V
Max 850mA

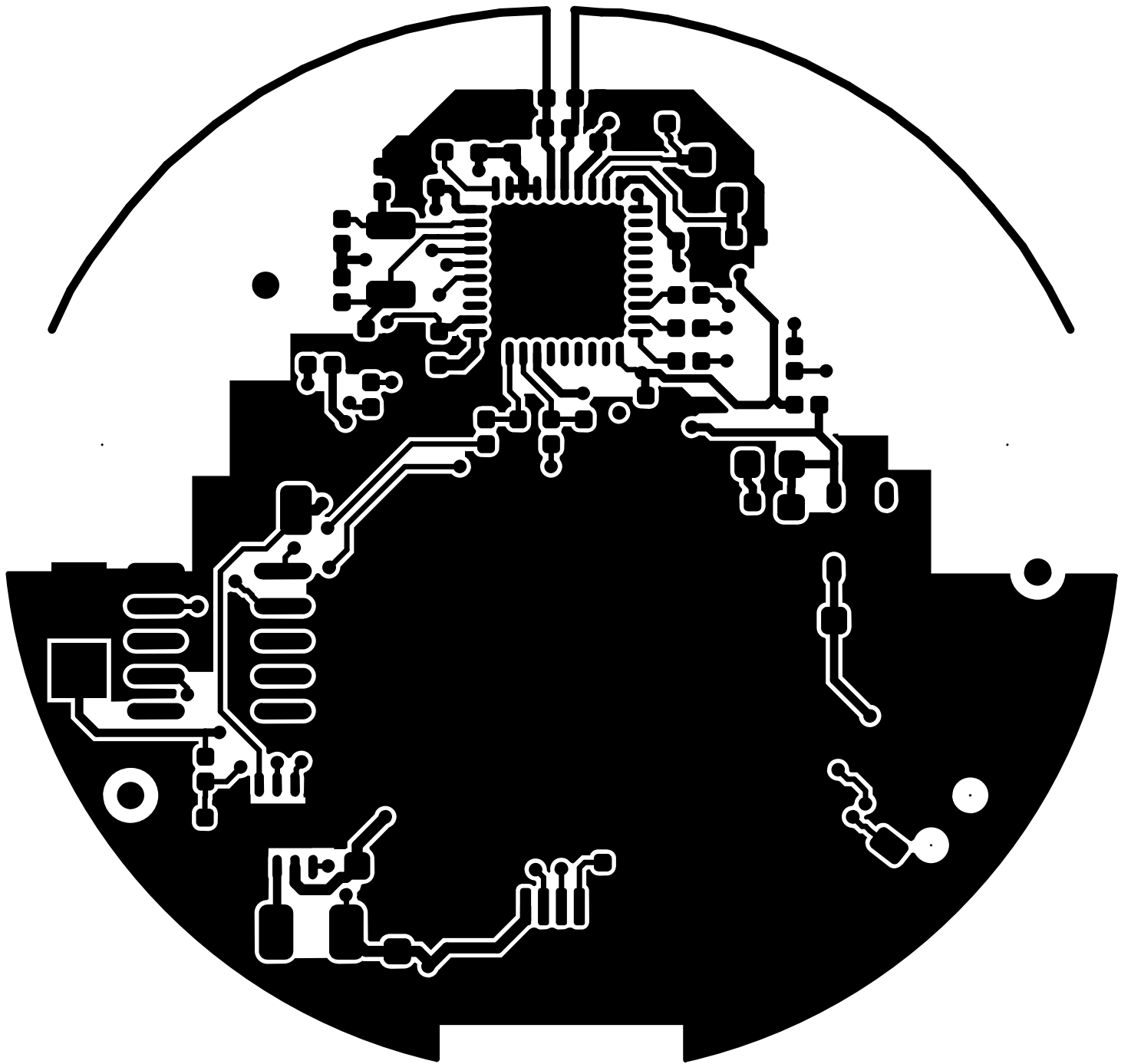


Caution
Hot surface









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